## **General Purpose Transistor**

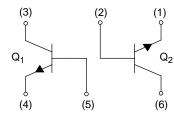
#### **NPN Silicon**

Moisture Sensitivity Level: 1 ESD Rating: Human Body Model – 4 kV Machine Model – 400 V

# ON

#### ON Semiconductor®

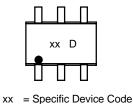
http://onsemi.com



# (5) (1

1 2 3 SOT-363/SC-88 CASE 419B STYLE 1

#### MARKING DIAGRAM



D = Date Code

#### ORDERING INFORMATION

Device	Package	Shipping		
MBT2222ADW1T1	SOT-363	3000/Tape & Reel		

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V <sub>CEO</sub>	40	Vdc
Collector–Base Voltage	V <sub>CBO</sub>	75	Vdc
Emitter-Base Voltage	$V_{\text{EBO}}$	6.0	Vdc
Collector Current – Continuous	Ι <sub>C</sub>	600	mAdc

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Package Dissipation (Note 1) $T_A = 25^{\circ}C$	P <sub>D</sub>	150	mW
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	833	°C/W
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

1. Device mounted on FR4 glass epoxy printed circuit board using the minimum recommended footprint.

#### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

Collector-Emitter Saturation Voltage (Note 2)

Base-Emitter Saturation Voltage (Note 2)

2. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

 $(I_C = 150 \text{ mAdc}, I_B = 15 \text{ mAdc}) \\ (I_C = 500 \text{ mAdc}, I_B = 50 \text{ mAdc})$ 

 $(I_{C} = 150 \text{ mAdc}, I_{B} = 15 \text{ mAdc})$ 

 $(I_C = 500 \text{ mAdc}, I_B = 50 \text{ mAdc})$ 

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector–Emitter Breakdown Voltage $(I_C = 10 \text{ mAdc}, I_B = 0)$	V <sub>(BR)CEO</sub>	40	-	Vdc
Collector–Base Breakdown Voltage $(I_C = 10 \ \mu Adc, I_E = 0)$	V <sub>(BR)CBO</sub>	75	-	Vdc
Emitter–Base Breakdown Voltage $(I_E = 10 \ \mu Adc, I_C = 0)$	V <sub>(BR)EBO</sub>	6.0	-	Vdc
Collector Cutoff Current (V <sub>CE</sub> = 60 Vdc, V <sub>EB(off)</sub> = 3.0 Vdc)	ICEX	_	10	nAdc
$      Collector Cutoff Current \\ (V_{CB} = 60 \ Vdc, \ I_E = 0) \\ (V_{CB} = 60 \ Vdc, \ I_E = 0, \ T_A = 125^\circ C) $	I <sub>CBO</sub>	- -	0.01 10	μAdc
Emitter Cutoff Current ( $V_{EB} = 3.0 \text{ Vdc}, I_C = 0$ )	I <sub>EBO</sub>	-	100	nAdc
Base Cutoff Current (V <sub>CE</sub> = 60 Vdc, V <sub>EB(off)</sub> = 3.0 Vdc)	I <sub>BL</sub>	-	20	nAdc
ON CHARACTERISTICS				
DC Current Gain ( $I_C = 0.1 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$ ) ( $I_C = 1.0 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$ ) ( $I_C = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$ ) ( $I_C = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, T_A = -55^{\circ}\text{C}$ ) ( $I_C = 150 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$ ) (Note 2) ( $I_C = 150 \text{ mAdc}, V_{CE} = 1.0 \text{ Vdc}$ ) (Note 2) ( $I_C = 500 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$ ) (Note 2)	h <sub>FE</sub>	35 50 75 35 100 50 40	- - - 300 -	_

0.3

1.0

1.2

2.0

Vdc

Vdc

\_ \_

0.6

\_

 $V_{\text{CE(sat)}}$ 

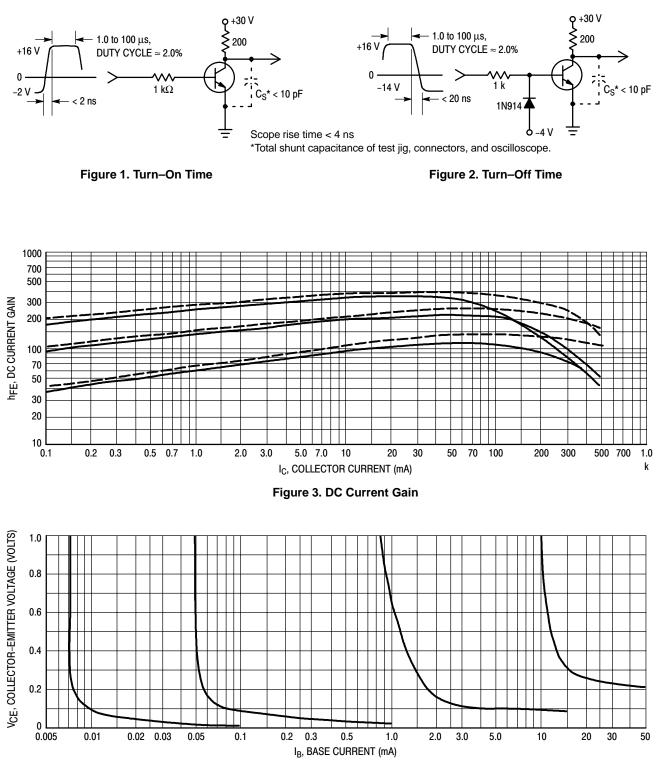
V<sub>BE(sat)</sub>

#### SMALL-SIGNAL CHARACTERISTICS

Current–Gain – Bandwidth Product (Note 3) (I <sub>C</sub> = 20 mAdc, V <sub>CE</sub> = 20 Vdc, f = 100 MHz)			300	-	MHz
Output Capacitance ( $V_{CB} = 10 \text{ Vdc}, I_E = 0, f = 1.0 \text{ MHz}$ )		C <sub>obo</sub>	-	8.0	pF
Input Capacitance ( $V_{EB} = 0.5 \text{ Vdc}$ , $I_C = 0$ , f = 1.0 MHz)		C <sub>ibo</sub>	-	25	pF
Input Impedance ( $I_C = 1.0 \text{ mAdc}$ , $V_{CE} = 10 \text{ Vdc}$ , $f = 1.0 \text{ kHz}$ ) ( $I_C = 10 \text{ mAdc}$ , $V_{CE} = 10 \text{ Vdc}$ , $f = 1.0 \text{ kHz}$ )		h <sub>ie</sub>	2.0 0.25	8.0 1.25	kΩ
Voltage Feedback Ratio ( $I_C = 1.0 \text{ mAdc}$ , $V_{CE} = 10 \text{ Vdc}$ , $f = 1.0 \text{ kHz}$ ) ( $I_C = 10 \text{ mAdc}$ , $V_{CE} = 10 \text{ Vdc}$ , $f = 1.0 \text{ kHz}$ )		h <sub>re</sub>		8.0 4.0	X 10 <sup>-4</sup>
$      Small–Signal Current Gain \\ (I_C = 1.0 mAdc, V_{CE} = 10 Vdc, f = 1.0 kHz) \\ (I_C = 10 mAdc, V_{CE} = 10 Vdc, f = 1.0 kHz) $		h <sub>fe</sub>	50 75	300 375	-
Output Admittance ( $I_C = 1.0 \text{ mAdc}$ , $V_{CE} = 10 \text{ Vdc}$ , f = 1.0 kHz) ( $I_C = 10 \text{ mAdc}$ , $V_{CE} = 10 \text{ Vdc}$ , f = 1.0 kHz)		h <sub>oe</sub>	5.0 25	35 200	μmhos
Collector Base Time Constant ( $I_E = 20 \text{ mAdc}$ , $V_{CB} = 20 \text{ Vdc}$ , f = 31.8 MHz)		rb, C <sub>c</sub>	_	150	ps
Noise Figure (I <sub>C</sub> = 100 $\mu$ Adc, V <sub>CE</sub> = 10 Vdc, R <sub>S</sub> = 1.0 kΩ, f = 1.0 kHz)		NF	_	4.0	dB
SWITCHING CHARACTERISTI	cs				
Delay Time	(V <sub>CC</sub> = 30 Vdc, V <sub>BE(off)</sub> = -0.5 Vdc,	t <sub>d</sub>	-	10	
Rise Time	$I_{\rm C} = 150 \text{ mAdc}, I_{\rm B1} = 15 \text{ mAdc})$	t <sub>r</sub>	-	25	ns
Storage Time	(V <sub>CC</sub> = 30 Vdc, I <sub>C</sub> = 150 mAdc,	t <sub>s</sub>	-	225	
Fall Time	$I_{B1} = I_{B2} = 15 \text{ mAdc}$	t <sub>f</sub>	-	60	ns

3.  $f_{T}$  is defined as the frequency at which  $|h_{fe}|$  extrapolates to unity.

#### SWITCHING TIME EQUIVALENT TEST CIRCUITS





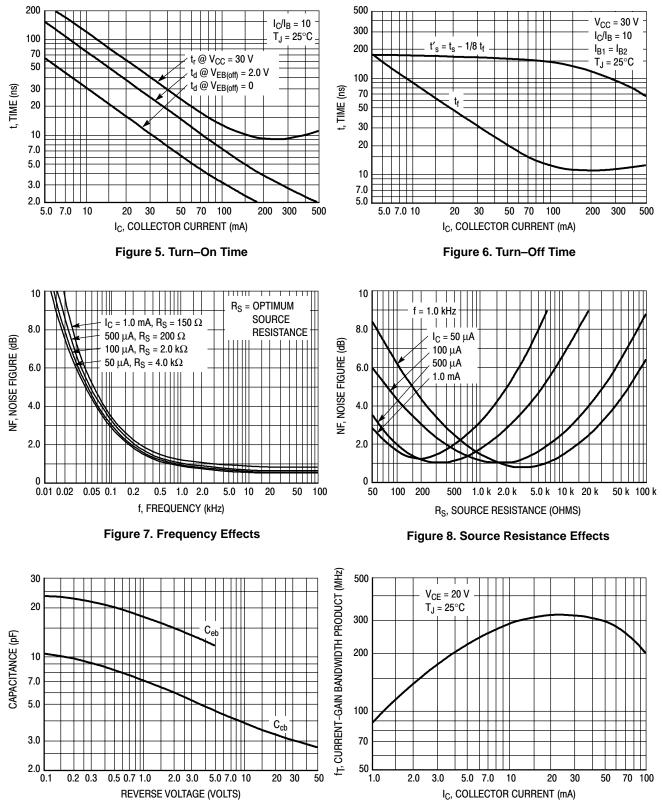


Figure 9. Capacitances

Figure 10. Current–Gain Bandwidth Product

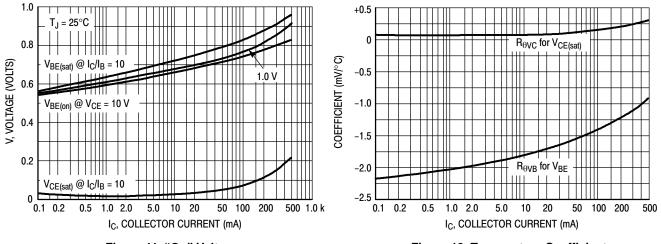
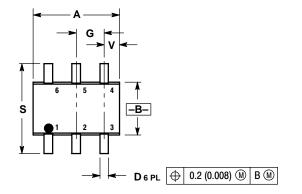


Figure 11. "On" Voltages

Figure 12. Temperature Coefficients

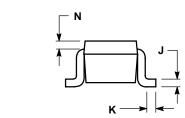
#### PACKAGE DIMENSIONS

SOT-363/SC-88 CASE 419B-01 ISSUE G



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 DIMEN Y14.5N	isioning 1, 1982. Rolling			NG PER A I.	٩N
	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.071	0.087	1.80	2.20	
В	0.045	0.053	1.15	1.35	
C	0.031	0.043	0.80	1.10	
D	0.004	0.012	0.10	0.30	
G	0.026 BSC		0.65 BSC		
Н		0.004		0.10	
J	0.004	0.010	0.10	0.25	
K	0.004	0.012	0.10	0.30	
Ν	0.008 REF		0.20	REF	
S	0.079	0.087	2.00	2.20	
V	0.012	0.016	0.30	0.40	

STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2

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